



flow90PACK 1

1200 V / 35 A

Topology features

- Inverter
- Kelvin Emitter for improved switching performance
- Tandem inverter diode
- Temperature sensor

Component features

- Easy paralleling
- Low turn-off losses
- Low collector emitter saturation voltage
- Positive temperature coefficient
- Short tail current
- Switching optimized for EMC

Housing features

- Base isolation: Al₂O₃
- 90° mounting angle between heatsink and PCB
- Screw-on heatsink mounting
- Thermo-mechanical push-and-pull force relief
- Solder pin

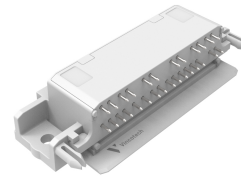
Target applications

- Industrial Drives

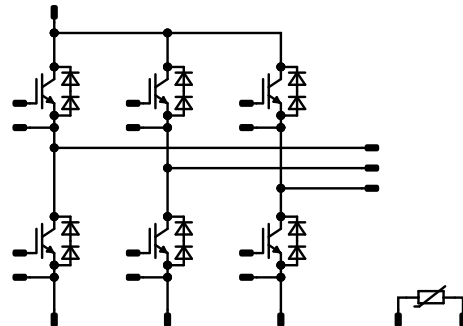
Types

- 10-R1126TA035M7-P700F71

flow90 1 housing



Schematic





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Maximum Ratings

$T_j = 25\text{ °C}$, unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
Inverter Switch				
Collector-emitter voltage	V_{CES}		1200	V
Collector current (DC current)	I_C	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	51	A
Repetitive peak collector current	I_{CRM}	t_p limited by T_{jmax}	70	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	107	W
Gate-emitter voltage	V_{GES}		± 20	V
Short circuit ratings	t_{SC}	$V_{GE} = 15\text{ V}$, $V_{CC} = 800\text{ V}$ $T_j = 150\text{ °C}$	9,5	μs
Maximum junction temperature	T_{jmax}		175	$^{\circ}\text{C}$

Inverter Diode

Peak repetitive reverse voltage	V_{RRM}		1300	V
Forward current (DC current)	I_F	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	31	A
Repetitive peak forward current	I_{FRM}	t_p limited by T_{jmax}	60	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	91	W
Maximum junction temperature	T_{jmax}		175	$^{\circ}\text{C}$

Module Properties

Thermal Properties

Storage temperature	T_{stg}		-40...+125	$^{\circ}\text{C}$
Operation temperature under switching condition	T_{jop}		-40...+($T_{jmax} - 25$)	$^{\circ}\text{C}$

Isolation Properties

Isolation voltage	V_{isol}	DC Test Voltage* $t_p = 2\text{ s}$	6000	V
Isolation voltage	V'_{isol}	AC Voltage $t_p = 1\text{ min}$	2500	V
Creepage distance			>12,7	mm
Clearance			11,67	mm
Comparative Tracking Index	CTI		≥ 200	

*100 % tested in production



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Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
		V_{GE} [V] V_{GS} [V]	V_{CE} [V] V_{DS} [V] V_F [V]	I_C [A] I_D [A] I_F [A]	T_j [°C]	Min	Typ	Max		

Inverter Switch

Static

Gate-emitter threshold voltage	$V_{GE(th)}$		10	0,0035	25	5,4	6	6,6	V
Collector-emitter saturation voltage	$V_{CE(sat)}$	15		35	25 125 150		1,47 1,64 1,68	1,85 ⁽¹⁾	V
Collector-emitter cut-off current	I_{CES}	0	1200		25			80	μA
Gate-emitter leakage current	I_{GES}	20	0		25			200	nA
Internal gate resistance	r_g						None		Ω
Input capacitance	C_{ies}						7900		pF
Output capacitance	C_{oes}	0	10		25		270		pF
Reverse transfer capacitance	C_{res}						97		pF
Gate charge	Q_g	$V_{CC} = 600$ V	0/15		35	25	260		nC

Thermal

Thermal resistance junction to sink ⁽²⁾	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)					0,89		K/W
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Dynamic

Turn-on delay time	$t_{d(on)}$					25 125 150	129,12 127,12 126,81		ns
Rise time	t_r	$R_{gon} = 8$ Ω $R_{goff} = 8$ Ω				25 125 150	22,51 25,64 26,09		ns
Turn-off delay time	$t_{d(off)}$		±15	600	35	25 125 150	172,27 197,75 204,31		ns
Fall time	t_f					25 125 150	99,43 125,75 133,62		ns
Turn-on energy (per pulse)	E_{on}	$Q_{tFWD} = 0,838$ μC $Q_{tFWD} = 1,63$ μC $Q_{tFWD} = 1,87$ μC				25 125 150	1,2 1,72 1,85		mWs
Turn-off energy (per pulse)	E_{off}					25 125 150	2,56 3,45 3,67		mWs



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10-R1126TA035M7-P700F71
datasheet

Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
		V_{GE} [V] V_{GS} [V]	V_{CE} [V] V_{DS} [V] V_F [V]	I_C [A] I_D [A] I_F [A]	T_j [°C]	Min	Typ	Max		
Inverter Diode										
Static										
Forward voltage	V_F				30	25 125 150		3,19 3,01 2,93	3,84 ⁽¹⁾	V
Reverse leakage current	I_R	$V_r = 1300$ V				25			1,6	μA
Thermal										
Thermal resistance junction to sink ⁽²⁾	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)						1,04		K/W
Dynamic										
Peak recovery current	I_{RM}	$di/dt=1488$ A/μs $di/dt=1200$ A/μs $di/dt=1199$ A/μs	±15	600	35	25 125 150		16,73 21,26 22,66		A
Reverse recovery time	t_{rr}					25 125 150		90,09 129,82 142,78		ns
Recovered charge	Q_r					25 125 150		0,838 1,63 1,87		μC
Reverse recovered energy	E_{rec}					25 125 150		0,305 0,597 0,694		mWs
Peak rate of fall of recovery current	$(di_r/dt)_{max}$					25 125 150		281,39 234,98 208,1		A/μs



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Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
		V_{GS} [V]	V_{GE} [V]	V_{DS} [V]	V_{CE} [V]	T_j [°C]	Min	Typ	Max	

Thermistor

Static

Rated resistance	R					25		22		kΩ
Deviation of R_{100}	$A_{R/R}$	$R_{100} = 1484 \Omega$				100	-5		5	%
Power dissipation	P					25		130		mW
Power dissipation constant	d					25		1,5		mW/K
B-value	$B_{(25/50)}$	Tol. $\pm 1 \%$						3962		K
B-value	$B_{(25/100)}$	Tol. $\pm 1 \%$						4000		K
Vincotech Thermistor Reference									I	

⁽¹⁾ Value at chip level

⁽²⁾ Only valid with pre-applied Vincotech thermal interface material.

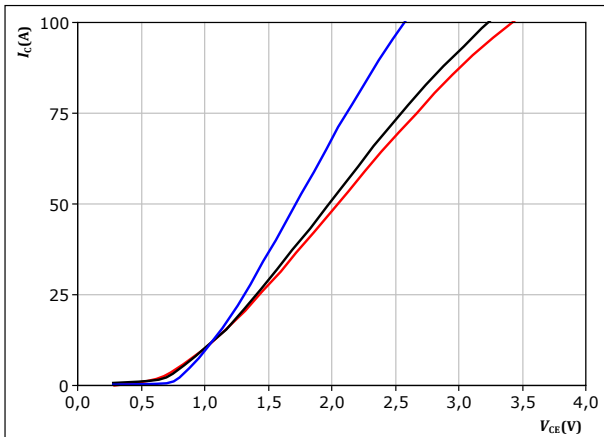


Inverter Switch Characteristics

figure 1. IGBT

Typical output characteristics

$$I_C = f(V_{CE})$$

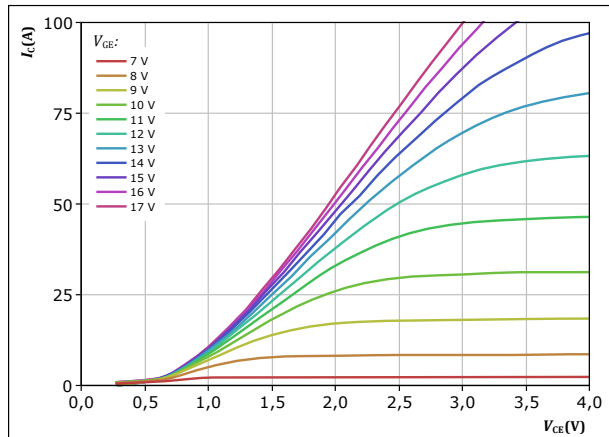


$t_p = 250 \mu s$
 $V_{GE} = 15 V$
 T_j : 25 °C, 125 °C, 150 °C

figure 2. IGBT

Typical output characteristics

$$I_C = f(V_{CE})$$

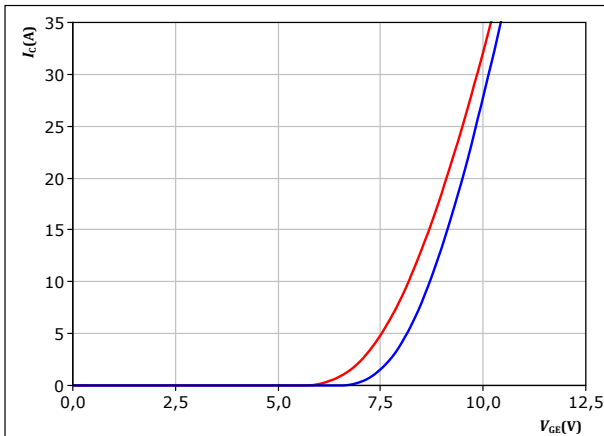


$t_p = 250 \mu s$
 $T_j = 150 \text{ °C}$
 V_{GE} from 7 V to 17 V in steps of 1 V

figure 3. IGBT

Typical transfer characteristics

$$I_C = f(V_{GE})$$

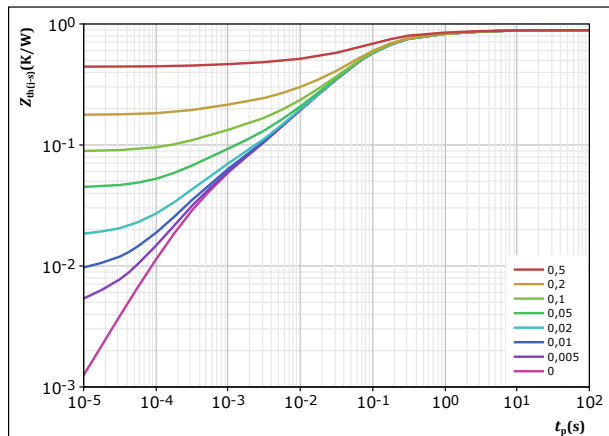


$t_p = 250 \mu s$
 $V_{CE} = 10 V$
 T_j : 25 °C, 125 °C

figure 4. IGBT

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



$D = t_p / T$
 $R_{th(j-s)} = 0,888 \text{ K/W}$

IGBT thermal model values

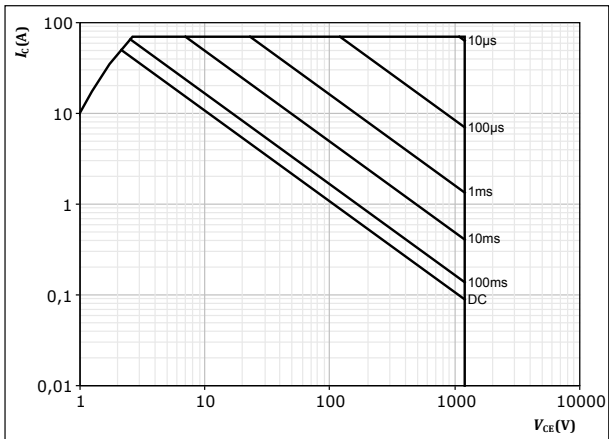
R (K/W)	τ (s)
4,56E-02	3,89E+00
8,84E-02	7,65E-01
3,30E-01	1,35E-01
2,86E-01	4,71E-02
8,94E-02	7,49E-03
3,24E-02	8,15E-04
1,67E-02	2,52E-04



Inverter Switch Characteristics

figure 5. IGBT

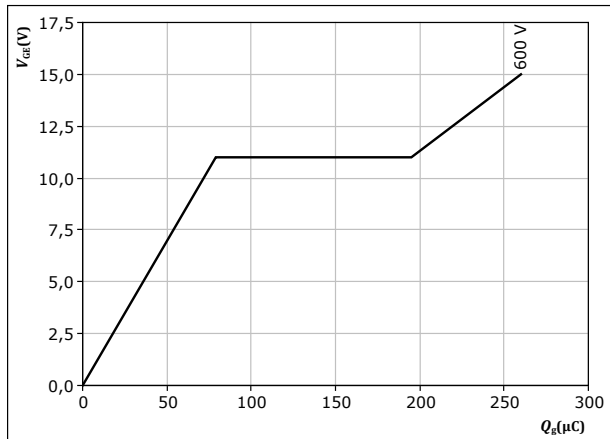
Safe operating area
 $I_C = f(V_{CE})$



$D =$ single pulse
 $T_s = 80$ °C
 $V_{GE} = 15$ V
 $T_j = T_{jmax}$

figure 6. IGBT

Gate voltage vs gate charge
 $V_{GE} = f(Q_g)$



$I_C = 35$ A
 $T_j = 25$ °C



Inverter Diode Characteristics

figure 7. FWD

Typical forward characteristics

$$I_F = f(V_F)$$

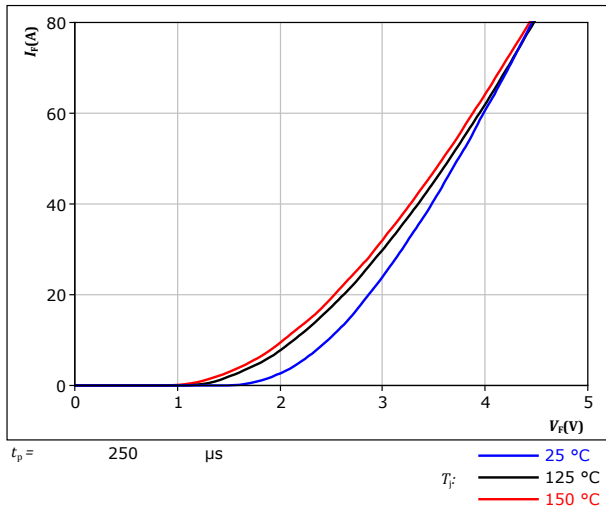
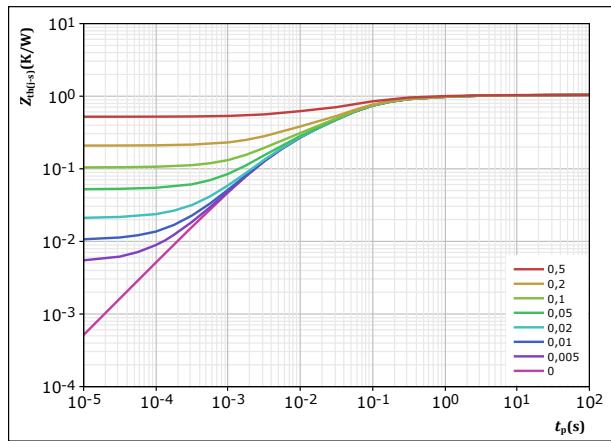


figure 8. FWD

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



$D = t_p / T$
 $R_{th(j-s)} = 1,043$ K/W
 FWD thermal model values

R (K/W)	τ (s)
1,84E-02	3,09E+01
9,18E-02	1,45E+00
2,98E-01	1,55E-01
4,70E-01	4,05E-02
1,65E-01	4,35E-03

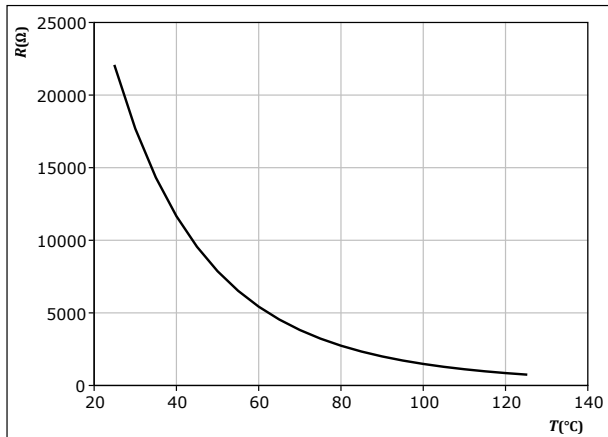


Thermistor Characteristics

figure 9. Thermistor

Typical NTC characteristic as function of temperature

$$R_T = f(T)$$

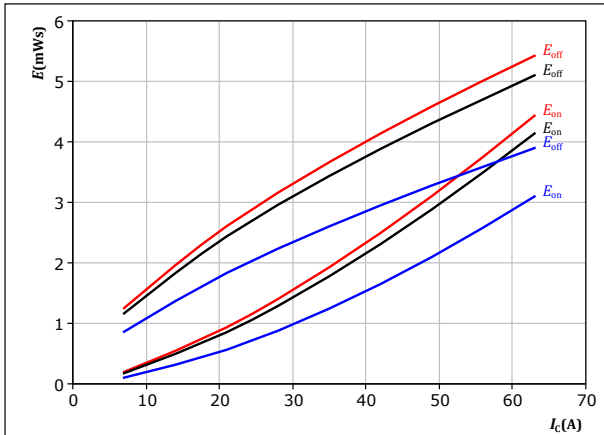




Inverter Switching Characteristics

figure 10. IGBT

Typical switching energy losses as a function of collector current
 $E = f(I_c)$

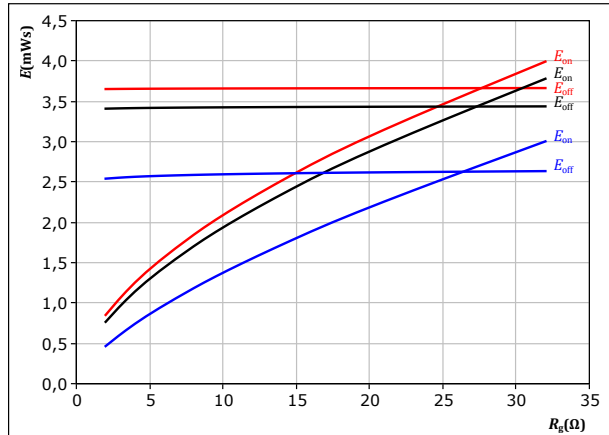


With an inductive load at

$V_{CE} = 600$ V	$T_j: 25$ °C
$V_{GE} = \pm 15$ V	$T_j: 125$ °C
$R_{g(on)} = 8$ Ω	$T_j: 150$ °C
$R_{g(off)} = 8$ Ω	

figure 11. IGBT

Typical switching energy losses as a function of IGBT turn on gate resistor
 $E = f(R_g)$

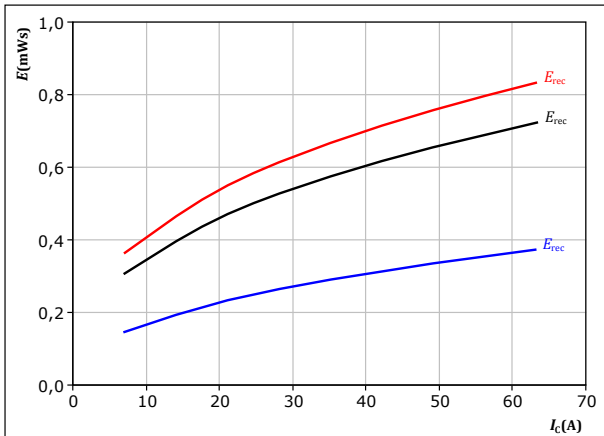


With an inductive load at

$V_{CE} = 600$ V	$T_j: 25$ °C
$V_{GE} = \pm 15$ V	$T_j: 125$ °C
$I_c = 35$ A	$T_j: 150$ °C

figure 12. FWD

Typical reverse recovered energy loss as a function of collector current
 $E_{rec} = f(I_c)$

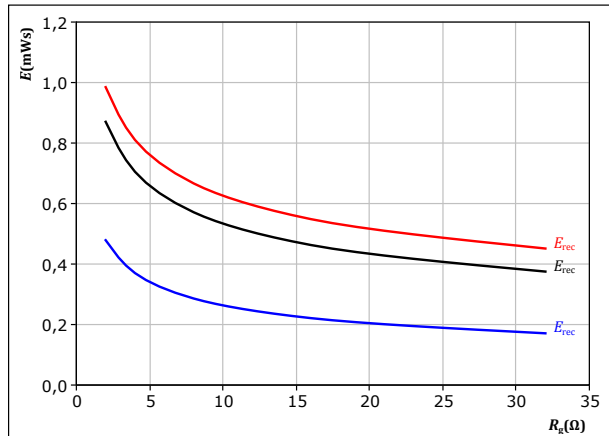


With an inductive load at

$V_{CE} = 600$ V	$T_j: 25$ °C
$V_{GE} = \pm 15$ V	$T_j: 125$ °C
$R_{g(on)} = 8$ Ω	$T_j: 150$ °C

figure 13. FWD

Typical reverse recovered energy loss as a function of IGBT turn on gate resistor
 $E_{rec} = f(R_g)$



With an inductive load at

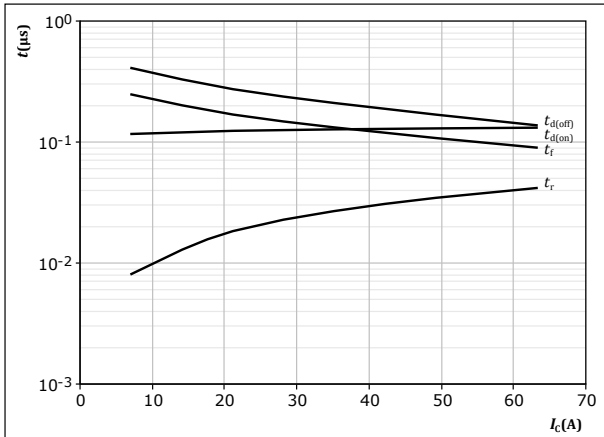
$V_{CE} = 600$ V	$T_j: 25$ °C
$V_{GE} = \pm 15$ V	$T_j: 125$ °C
$I_c = 35$ A	$T_j: 150$ °C



Inverter Switching Characteristics

figure 14. IGBT

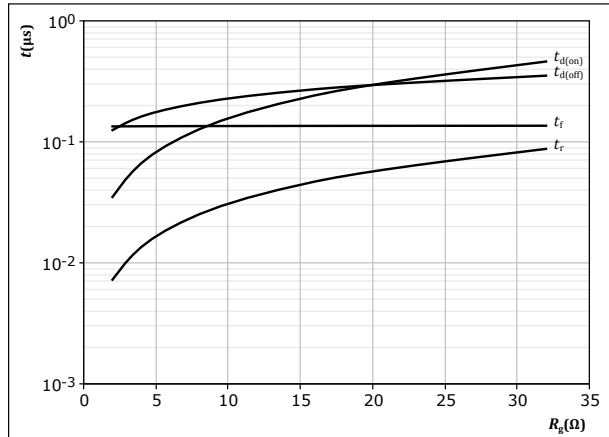
Typical switching times as a function of collector current
 $t = f(I_c)$



With an inductive load at
 $T_j = 150$ °C
 $V_{CE} = 600$ V
 $V_{GE} = \pm 15$ V
 $R_{gon} = 8$ Ω
 $R_{goff} = 8$ Ω

figure 15. IGBT

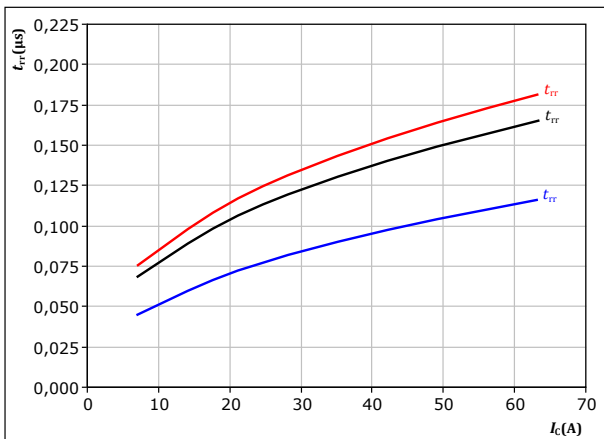
Typical switching times as a function of IGBT turn on gate resistor
 $t = f(R_g)$



With an inductive load at
 $T_j = 150$ °C
 $V_{CE} = 600$ V
 $V_{GE} = \pm 15$ V
 $I_c = 35$ A

figure 16. FWD

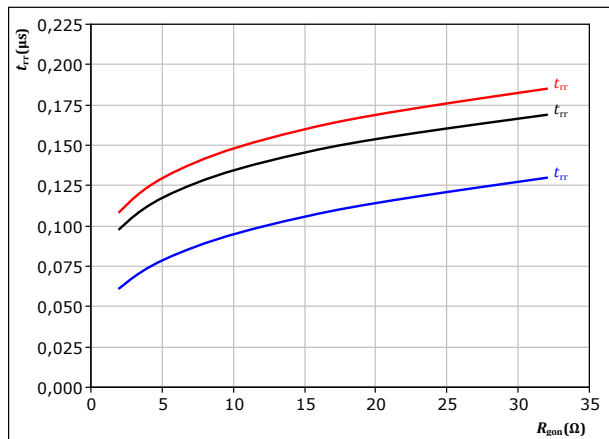
Typical reverse recovery time as a function of collector current
 $t_{rr} = f(I_c)$



With an inductive load at
 $V_{CE} = 600$ V
 $V_{GE} = \pm 15$ V
 $R_{gon} = 8$ Ω
 T_j : — 25 °C
 — 125 °C
 — 150 °C

figure 17. FWD

Typical reverse recovery time as a function of IGBT turn on gate resistor
 $t_{rr} = f(R_{gon})$



With an inductive load at
 $V_{CE} = 600$ V
 $V_{GE} = \pm 15$ V
 $I_c = 35$ A
 T_j : — 25 °C
 — 125 °C
 — 150 °C

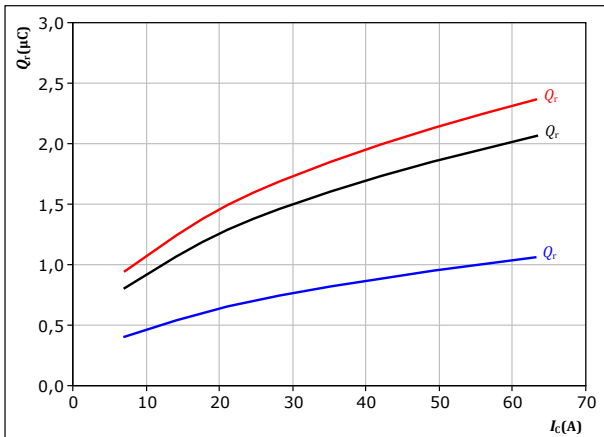


Inverter Switching Characteristics

figure 18. FWD

Typical recovered charge as a function of collector current

$$Q_r = f(I_c)$$



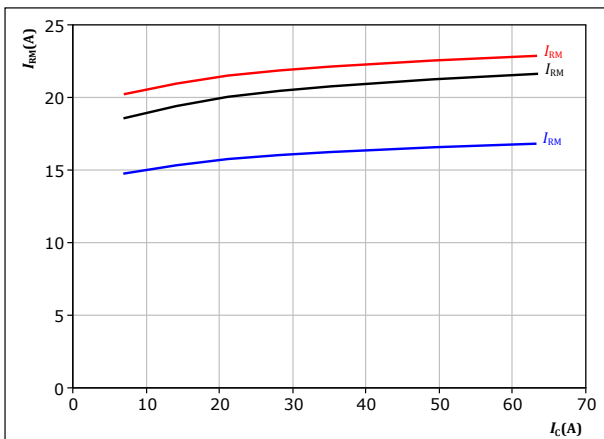
With an inductive load at

$V_{CE} = 600$ V
 $V_{GE} = \pm 15$ V
 $R_{gon} = 8$ Ω
 T_j : 25 °C (blue), 125 °C (black), 150 °C (red)

figure 20. FWD

Typical peak reverse recovery current as a function of collector current

$$I_{RM} = f(I_c)$$



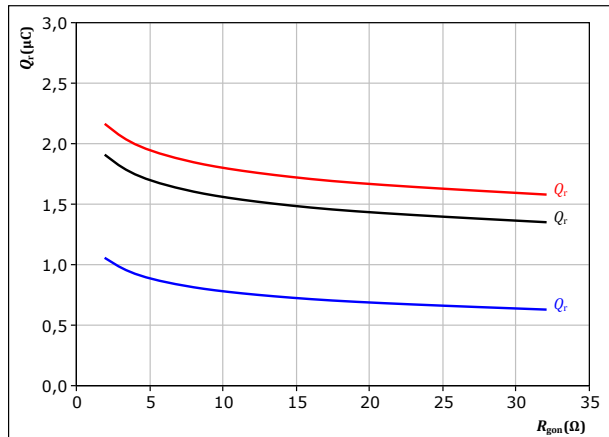
With an inductive load at

$V_{CE} = 600$ V
 $V_{GE} = \pm 15$ V
 $R_{gon} = 8$ Ω
 T_j : 25 °C (blue), 125 °C (black), 150 °C (red)

figure 19. FWD

Typical recovered charge as a function of IGBT turn on gate resistor

$$Q_r = f(R_{gon})$$



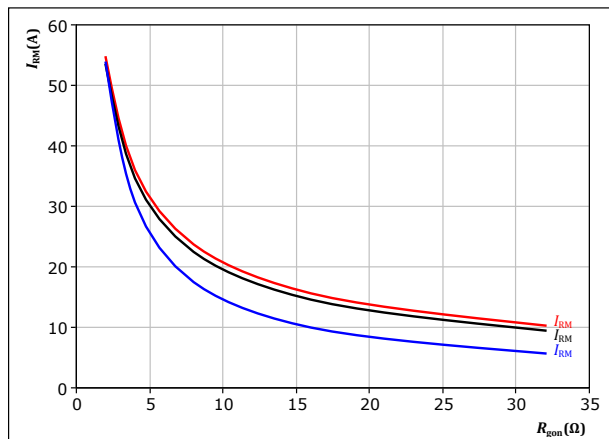
With an inductive load at

$V_{CE} = 600$ V
 $V_{GE} = \pm 15$ V
 $I_c = 35$ A
 T_j : 25 °C (blue), 125 °C (black), 150 °C (red)

figure 21. FWD

Typical peak reverse recovery current as a function of IGBT turn on gate resistor

$$I_{RM} = f(R_{gon})$$



With an inductive load at

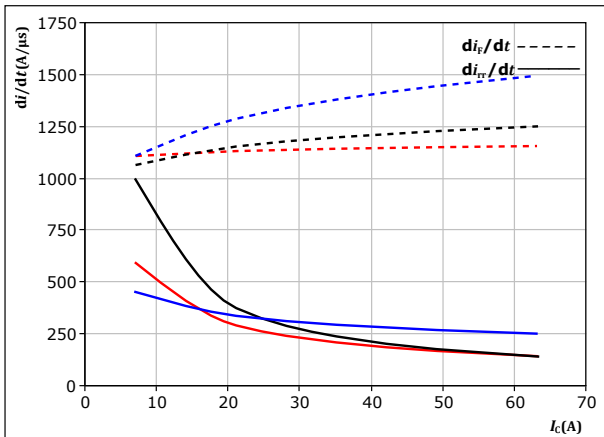
$V_{CE} = 600$ V
 $V_{GE} = \pm 15$ V
 $I_c = 35$ A
 T_j : 25 °C (blue), 125 °C (black), 150 °C (red)



Inverter Switching Characteristics

figure 22. FWD

Typical rate of fall of forward and reverse recovery current as a function of collector current
 $di_i/dt, di_r/dt = f(I_C)$

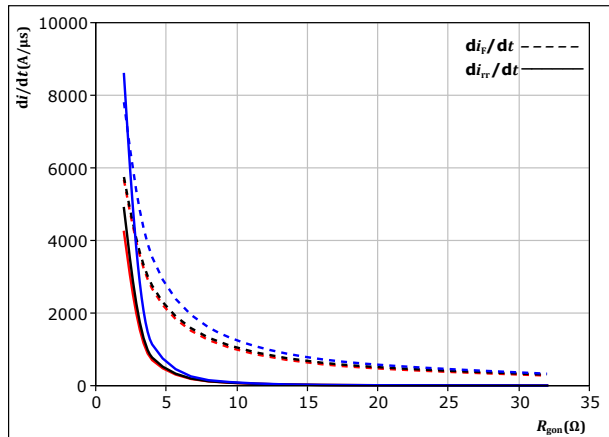


With an inductive load at

$V_{CE} =$	600	V	$T_j =$	25 °C
$V_{GE} =$	±15	V		125 °C
$R_{gon} =$	8	Ω		150 °C

figure 23. FWD

Typical rate of fall of forward and reverse recovery current as a function of turn on gate resistor
 $di_i/dt, di_r/dt = f(R_{gon})$

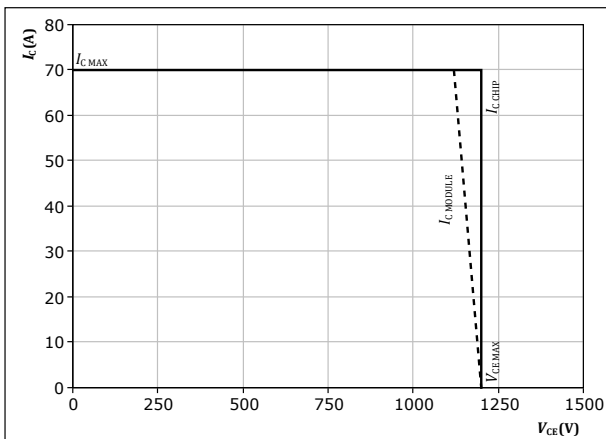


With an inductive load at

$V_{CE} =$	600	V	$T_j =$	25 °C
$V_{GE} =$	±15	V		125 °C
$I_C =$	35	A		150 °C

figure 24. IGBT

Reverse bias safe operating area
 $I_C = f(V_{CE})$



At $T_j =$ 150 °C
 $R_{gon} =$ 8 Ω
 $R_{goff} =$ 8 Ω



Inverter Switching Definitions

figure 25. IGBT
Turn-off Switching Waveforms & definition of t_{doff} , t_{Eoff} (t_{Eoff} = integrating time for E_{off})

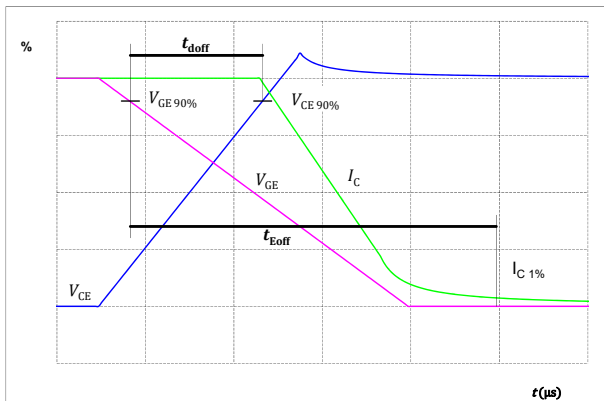


figure 26. IGBT
Turn-on Switching Waveforms & definition of t_{don} , t_{Eon} (t_{Eon} = integrating time for E_{on})

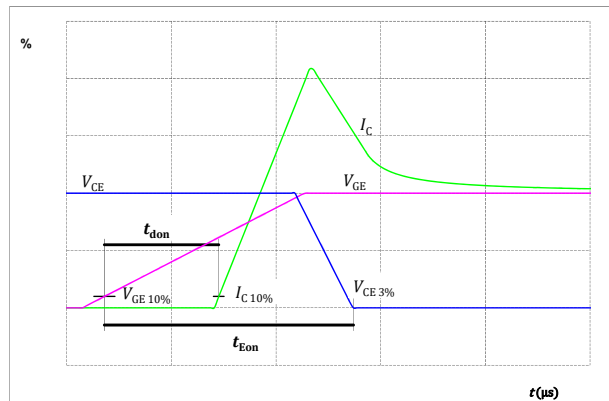


figure 27. IGBT
Turn-off Switching Waveforms & definition of t_f

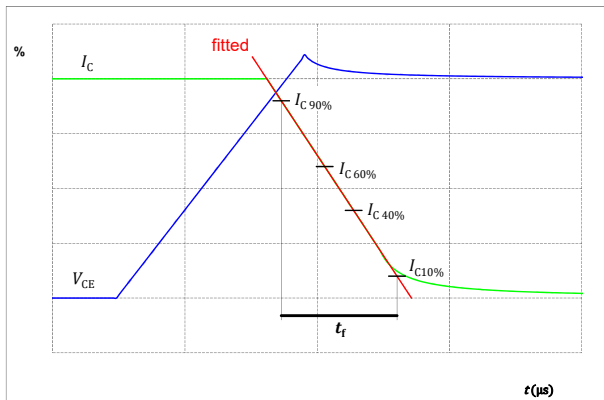
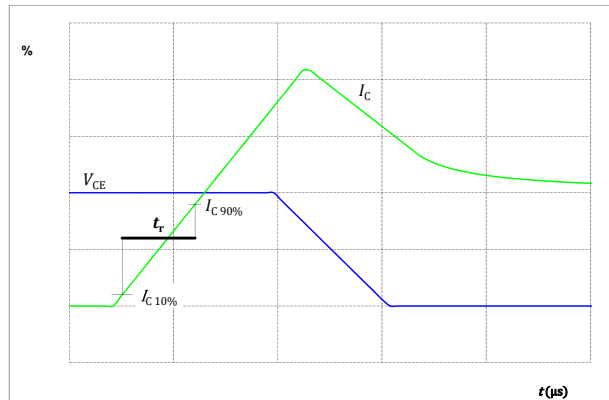


figure 28. IGBT
Turn-on Switching Waveforms & definition of t_r





Inverter Switching Definitions

figure 29. FWD

Turn-off Switching Waveforms & definition of t_{rr}

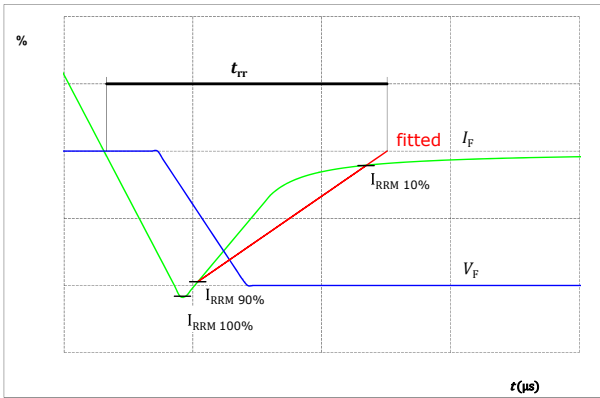
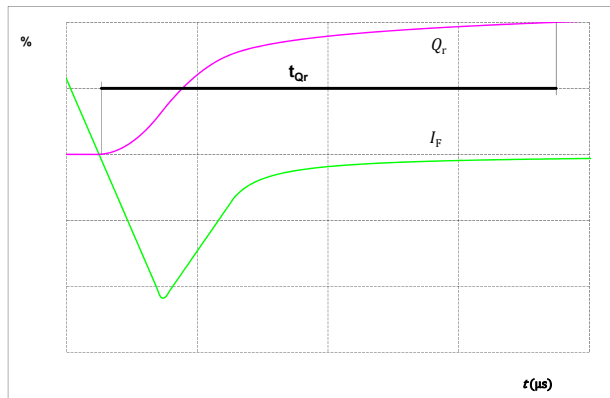


figure 30. FWD

Turn-on Switching Waveforms & definition of t_{Qr} (t_{Qr} = integrating time for Q_r)





Vincotech

10-R1126TA035M7-P700F71
datasheet

Ordering Code	
Version	Ordering Code
Without thermal paste	10-R1126TA035M7-P700F71
With thermal paste (3,4 W/mK, PSX-P7)	10-R1126TA035M7-P700F71-/3/

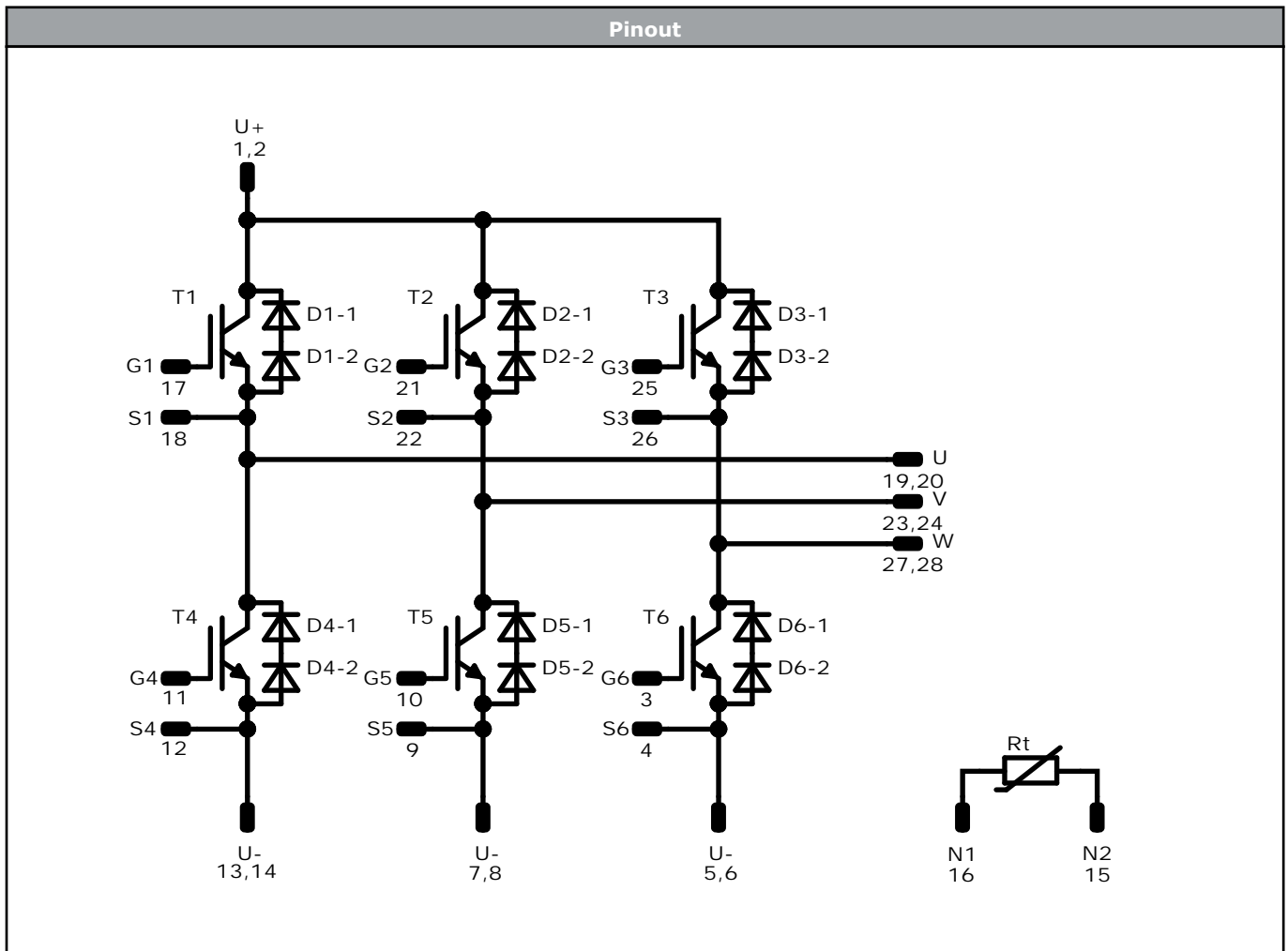
Marking							
	Text	VIN	Date code	Type&Ver	UL	Lot	Serial
		VIN	WWYY	TTTTTTV	UL	LLLLL	SSSS
	Datamatrix	Type&Ver	Lot number	Serial	Date code		
		TTTTTTV	LLLLL	SSSS	WWYY		

Pin table [mm]				Outline
Pin	X	Y	Function	
1	53	0	U+	
2	50	0	U+	
3	43	0	G6	
4	40	0	S6	
5	37	0	U-	
6	34,1	0	U-	
7	31	0	U-	
8	28,1	0	U-	
9	24,05	0	S5	
10	21,05	0	G5	
11	17	0	G4	
12	12,95	0	S4	
13	8,9	0	U-	
14	6	0	U-	
15	3	0	N2	
16	0	0	N1	
17	0	7	G1	
18	3	7	S1	
19	7,2	7	U	
20	10,2	7	U	
21	17,2	7	G2	
22	20,2	7	S2	
23	29,75	7	V	
24	32,75	7	V	
25	39,75	7	G3	
26	42,75	7	S3	
27	47	7	W	
28	50	7	W	

Tolerance of pinpositions ±0.5mm at the end of pins
Dimension of coordinate axis is only offset without tolerance



Vincotech



Identification					
ID	Component	Voltage	Current	Function	Comment
T4, T1, T5, T2, T6, T5	IGBT	1200 V	35 A	Inverter Switch	
D1, D4, D2, D5, D3, D6	FWD	1300 V	30 A	Inverter Diode	Values apply to tandem devices
Rt	Thermistor			Thermistor	




Packaging instruction				
Standard packaging quantity (SPQ) 80	>SPQ	Standard	<SPQ	Sample

Handling instruction
Handling instructions for <i>flow90</i> 1 packages see vincotech.com website.

Package data
Package data for <i>flow90</i> 1 packages see vincotech.com website.

Vincotech thermistor reference
See Vincotech thermistor reference table at vincotech.com website.

UL recognition and file number
This device is certified according to UL 1557 standard, UL file number E192116. For more information see vincotech.com website. 

Document No.:	Date:	Modification:	Pages
10-R1126TA035M7-P700F71-D1-14	16 Jun. 2022		

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2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.